

ABSTRACT

According to the type of the plate (6, 6w, 6t) placed in a plate placing device (12) of a component feeder (4), appropriate holding operation and expanding operation
5 are performed selectively and automatically according to the type of the plate by regulating the lowered position of a plate pressurizing member (61) for the tray feeding plate (6t) to securely hold the plate and performing wafer
expanding while securely holding the wafer feeding plate by
10 releasing the regulation of the lowered position for the wafer feeding plate (6w).